



In the United States Patent and Trademark Office

AF/1700
\$8
COPY OF PAPERS
ORIGINALLY FILED

In re the Application of
Bowles, et al.

TI-24521

Serial No.: 09/732,468

Art Unit: 1765

Filed: December 7, 2000

Examiner: V. Perez-Ramos

Title: Method for Unpatterned Resist Etch Back of Shallow
Trench Isolation Refill Insulator

August 30, 2002

Assistant Commissioner for
Patents
Washington, D.C. 20231

MAILING CERTIFICATE UNDER 37 C.F.R. §1.8(A)
I hereby certify that the above correspondence is
being deposited with the U.S. Postal Service as
U.S. Mail in an envelope addressed to: Assistant
Commissioner for Patents, Washington, D.C. 20231
on August 30, 2002.

Jackie McBride
Jackie McBride

Dear Sir:

Transmitted herewith is an amendment in this application.

The fee has been calculated as shown below.

CLAIMS AS AMENDED						
	CLAIMS REMAINING AFTER AMENDMENT		HIGHEST NUMBER PREVIOUSLY PAID FOR	PRESENT EXTRA	RATE	ADDITIONAL FEE
Total Claims	19	Minus	21	= 0	x \$18 =	\$ 0
Ind. Claims	02	Minus	03	= 0	x \$84 =	\$ 0
TOTAL ADDITIONAL FEE FOR THIS AMOUNT						\$ 0

Under 37 C.F.R. § 1.16(k) please charge the total additional fee,
and any further fees, or credit overpayment to Deposit Account of
Texas Instruments Incorporated, No. 20-0668.

Respectfully submitted,

Yingsheng Tung

Yingsheng Tung
Reg. No. 52,305
Attorney for Applicants

Texas Instruments Incorporated
P.O. Box 655474, M/S 3999
Dallas, Texas 75265
(972) 917-5355



8/13
UP
9/12/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of
Bowles, et al.

TI-24521

COPY OF PAPERS
ORIGINALLY FILED

Serial No.: 09/732,468

Art Unit: 1765

Filed: December 7, 2000

Examiner: V. Perez-Ramos

Title: Method for Unpatterned Resist Etch Back of Shallow
Trench Isolation Refill Insulator

Amendment-A Under 37 CFR 1.116

RECEIVED
SEP 12 2002
TC 1760 MAIL ROOM

Assistant Commissioner of Patents
Washington, DC 20231
Box AF

MAILING CERTIFICATE UNDER 37 C.F.R. § 1.8(a)
I hereby certify that the above
correspondence is being deposited with the
U.S. Postal Service with sufficient postage
for First Class mail in an envelope addressed
to: Assistant Commissioner for Patents,
Washington D.C. 20231 on: 08/30/2002.

Jackie McBride
Jackie McBride

Dear Sir:

Responsive to Examiner's Office Action dated July 23,
2002, Applicants amend this application as follows:

In the Claims:

Cancel claims 12 and 21; amend claims 1, 2, 13, 14,
and 15 as follows:

1. A method for forming shallow trench isolation
structures, comprising:

forming a plurality of isolation trenches in a
substrate, the isolation trenches separating active areas;

B1